Si4491EDY

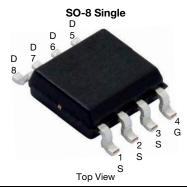
RoHS COMPLIANT

HALOGEN

Vishay Siliconix

www.vishay.com

P-Channel 30 V (D-S) MOSFET



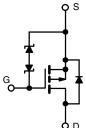
PRODUCT SUMMARY						
V _{DS} (V)	-30					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0065					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -6 V	0.0082					
$R_{DS(on)}$ max. (Ω) at V_GS = -4.5 V	0.0112					
Q _g typ. (nC)	66					
I _D (A) ^a	-29					
Configuration	Single					

FEATURES

- Extended V_{GS} range (± 25 V) for adaptor switch applications
- Extremely low R_{DS(on)}
- TrenchFET® power MOSFET
- 100 % R_{α} and UIS tested
- Typical ESD performance: 4000 V (HBM)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Adaptor switch, load switch
- Power management
- Notebook computers and portable battery packs



P-Channel MOSFET

ORDERING INFORMATION

Package	SO-8
Lead (Pb)-free and halogen-free	Si4491EDY-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-30	V	
Gate-source voltage		V _{GS}	± 25		
	T _C = 25 °C		-25.8		
	T _C = 70 °C		-20.7		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-17.3		
	T _A = 70 °C		-13.9 ^{b, c}		
Pulsed drain current (t = 300 μs)		I _{DM}	-60	— A	
Continuous source-drain diode current	T _C = 25 °C	1	-5.8 ^{b, c}		
	T _A = 25 °C	I _S	-2.6 ^{b, c}		
Single pulse avalanche current		I _{AS}	-40		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	80	mJ	
Maximum power dissipation	T _C = 25 °C		6.9		
	T _C = 70 °C		4.4	14/	
	T _A = 25 °C	P _D	3.1 ^{b, c}	W	
	T _A = 70 °C	1	2 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS PARAMETER SYMBOL TYPICAL Maximum junction-to-ambient ^{b, d} t < 10 s</td> Bm to 33

			-	-	-
Maximum junction-to-ambient b, d	$t \le 10 s$	R _{thJA}	33	40	°C/W
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	15	17	0/00

Notes

a. Based on $T_C = 25 \text{ °C}$ b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 90 °C/W

S12-2337-Rev. B, 01-Oct-12

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UNIT

MAXIMUM



Si4491EDY

Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	1 1		1		1	1	
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	1 050 A	-	-24	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μΑ	-	6	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-1.2	-	-2.8	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 25 V$	-	-	± 150	,	
		$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 15	1 .	
		$V_{DS} = -30 V, V_{GS} = 0 V$	-	-	-1	μΑ	
Zero gate voltage drain current	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-20	-	-	А	
		V _{GS} = -10 V, I _D = -13 A	-	0.0054	0.0065		
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -6 V, I _D = -10 A	-	0.0068	0.0082	Ω	
		$V_{GS} = -4.5 \text{ V}, I_D = -8 \text{ A}$	-	0.0093	0.0112		
Forward transconductance a		V _{DS} = -15 V, I _D = -13 A	-	44	-	S	
Dynamic ^b				•		•	
Input capacitance	C _{iss}		-	4620	-		
Output capacitance	Coss	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	880	-	pF	
Reverse transfer capacitance	C _{rss}		-	820	-		
Total and a share a	Qg	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -17.3 \text{ A}$	-	102	153	nC	
Total gate charge			-	66	80		
Gate-source charge	Q _{gs}	V_{DS} = -15 V, V_{GS} = -5 V, I_{D} = -17.3 A	-	16	-		
Gate-drain charge	Q _{gd}		-	28	-		
Gate resistance	Rg	f = 1 MHz	0.3	1.3	2.6	Ω	
Turn-on delay time	t _{d(on)}		-	70	105	1	
Rise time	t _r	$V_{DD} = 0 V, R_{L} = 1.5 \Omega,$	-	70	105		
Turn-off delay time	t _{d(off)}	$I_D \cong$ -10 Å, V_{GEN} = -4.5 V, R_g = 1 Ω	-	45	68		
Fall time	t _f		-	27	41		
Turn-on delay time	t _{d(on)}		-	18	30	ns	
Rise time	tr	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega,$	-	15	25		
Turn-off delay time	t _{d(off)}	$I_D \cong$ -10 A, V_{GEN} = -10 V, R_g = 1 Ω	-	52	80		
Fall time	t _f		-	14	25		
Drain-Source Body Diode Characteristi	cs						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-5.8		
Pulse diode forward current	I _{SM}			-	-60	A	
Body diode Voltage	V _{SD}	I _S = -10 A, V _{GS} = 0 V	-	-0.78	-1.2	V	
Body diode reverse recovery time	t _{rr}			35	53	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = -10 A, di/dt = 100 A/μs,		25	38	nC	
Reverse recovery fall time	t _a	$T_{\rm J} = 25 ^{\circ}{\rm C}$		19			
Reverse recovery rise time	t _b			16		ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

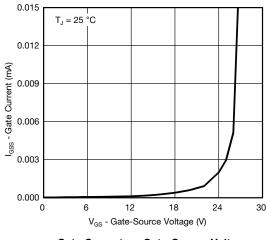
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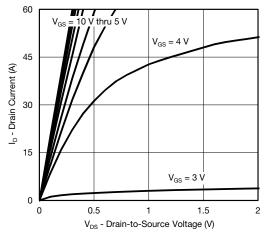
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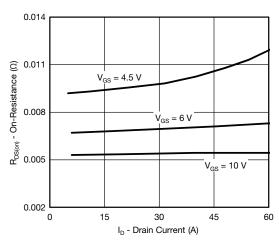
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



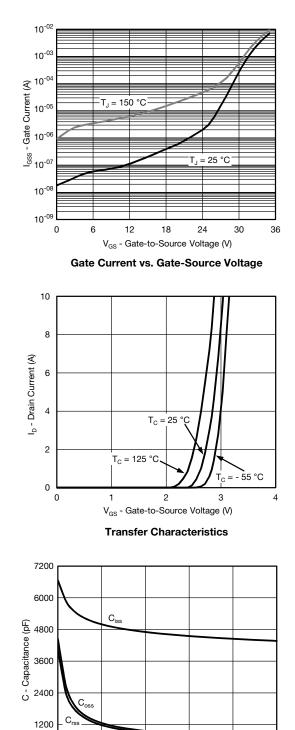
Gate Current vs. Gate-Source Voltage







On-Resistance vs. Drain Current



6 12 18 24 V_{DS} - Drain-to-Source Voltage (V)

Capacitance

0

0

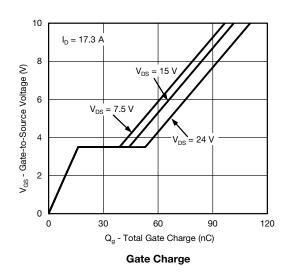
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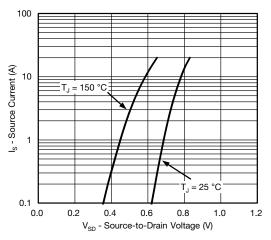
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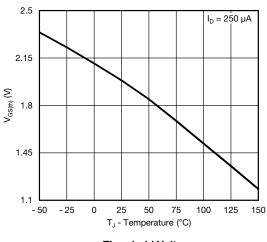
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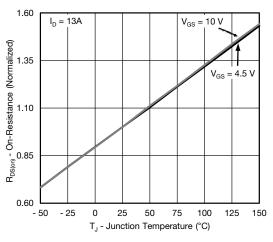




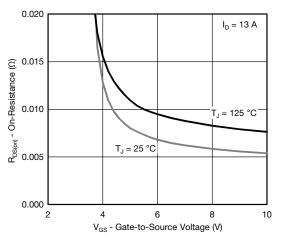
Source-Drain Diode Forward Voltage



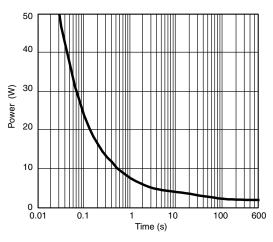
Threshold Voltage



On-Resistance vs. Junction Temperature







Single Pulse Power, Junction-to-Ambient

4

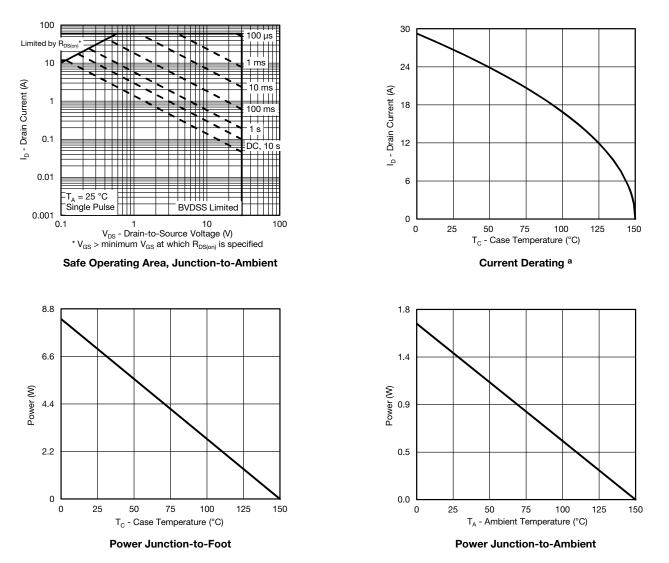
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

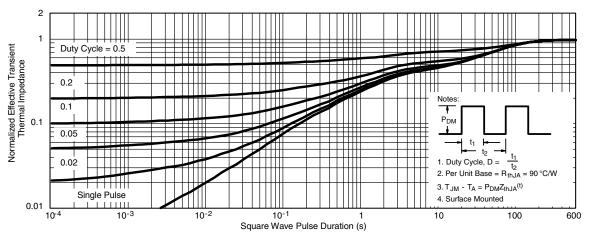
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

5

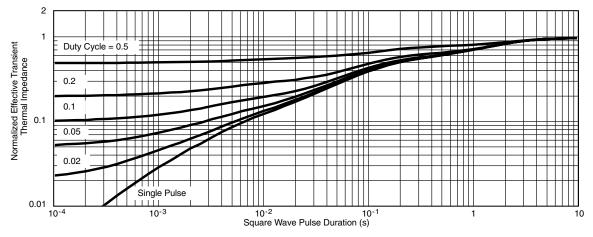


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

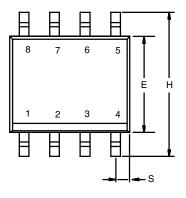
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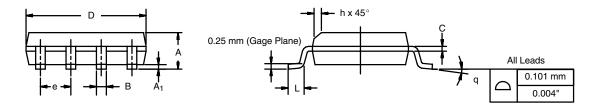


Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	INCHES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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